April 2009



FGH60N60SFD 600V, 60A Field Stop IGBT

Features

- · High current capability
- Low saturation voltage: V_{CE(sat)} =2.3V @ I_C = 60A
- · High input impedance
- · Fast switching
- · RoHS compliant

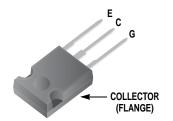
Applications

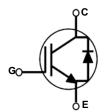
· Induction Heating, UPS, SMPS, PFC



General Description

Using Novel Field Stop IGBT Technology, Fairchild's new series of Field Stop IGBTs offer the optimum performance for Induction Heating, UPS, SMPS and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Units	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		± 20	V	
I _C	Collector Current	@ T _C = 25°C	120	А	
.0	Collector Current	$@ T_C = 100^{\circ}C$	60	А	
I _{CM (1)}	Pulsed Collector Current	$ T_C = 25^{\circ}C $	180	Α	
P _D	Maximum Power Dissipation	$@ T_C = 25^{\circ}C$	378	W	
ט י	Maximum Power Dissipation	$@ T_C = 100^{\circ}C$	151	W	
T _J	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:
1: Repetitive test, Pulse width limited by max. juntion temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.33	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	-	1.1	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Packaging Type	Qty per Tube	Max Qty per Box
FGH60N60SFD	FGH60N60SFDTU	TO-247	Tube	30ea	-

Electrical Characteristics of the IGBT $\,\,_{T_C\,=\,25^{\circ}\!C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250 \mu A$	600	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_J}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V, I_C = 250\mu A$	-	0.4	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	250	μА
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±400	nA
On Charac	teristics			•	•	
V _{GE(th)}	G-E Threshold Voltage	$I_{C} = 250 \mu A, V_{CE} = V_{GE}$	4.0	5.0	6.5	V
OL(III)		I _C = 60A, V _{GE} = 15V	-	2.3	2.9	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 60A, V _{GE} = 15V, T _C = 125°C	-	2.5	-	V
Dynamic C	haracteristics			•	1	
C _{ies}	Input Capacitance		-	2820	-	pF
C _{oes}	Output Capacitance	$V_{CE} = 30V_{,} V_{GE} = 0V_{,}$ f = 1MHz	-	350	-	pF
C _{res}	Reverse Transfer Capacitance	1 = 1WIDZ	-	140	-	pF
	Characteristics			1	I	
t _{d(on)}	Turn-On Delay Time		-	22	-	ns
t _r	Rise Time		-	42	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 400V, I_{C} = 60A,$ $R_{G} = 5\Omega, V_{GE} = 15V,$	-	134	-	ns
t _f	Fall Time	Inductive Load, $T_C = 25^{\circ}C$	-	31	62	ns
E _{on}	Turn-On Switching Loss		-	1.79	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.67	-	mJ
E _{ts}	Total Switching Loss		-	2.46	-	mJ
t _{d(on)}	Turn-On Delay Time Rise Time		-	44	-	ns
t _r		.,	-	144		ns
t _{d(off)}	Turn-Off Delay Time Fall Time	$V_{CC} = 400V, I_{C} = 60A,$ $R_{G} = 5\Omega, V_{GE} = 15V,$	-	43	-	ns
t _f		Inductive Load, T _C = 125°C	-	1.88	-	ns mJ
E _{off}	Turn-On Switching Loss	-	-	1.08		mJ
E _{ts}	Turn-Off Switching Loss Total Switching Loss		-	2.88		mJ
Q _q	Total Gate Charge		-	198		nC
Q _{ge}	Gate to Emitter Charge	$V_{CE} = 400V, I_{C} = 60A,$	-	22	 	nC
	-	V _{GE} = 15V	-	106	-	nC
Q _{gc}	Gate to Collector Charge			100		IIC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Units
V _{FM}	Diode Forward Voltage	I _F = 30A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	2.0	2.6	V
V _{FM}	2.000 r ormana romago		$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.8	-]
t _{rr}	Diode Reverse Recovery Time		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	47	-	ns
711	Didde Neverse Necestery Time	I _{ES} = 30A, dI _{ES} /dt = 200A/μs	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	179	ı	
Q _{rr}	Diode Reverse Recovery Charge	1Ες = 50/1, αιες/αι = 250/1/μ5	$T_C = 25^{\circ}C$	-	83	-	nC
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	567	-	

Figure 1. Typical Output Characteristics

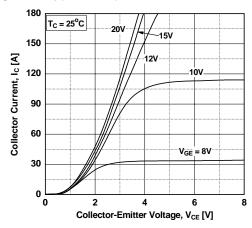


Figure 3. Typical Saturation Voltage Characteristics

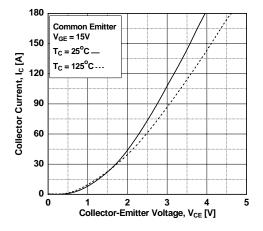


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level

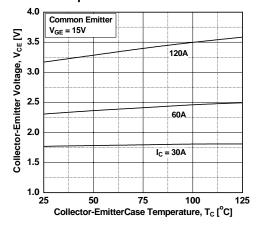


Figure 2. Typical Output Characteristics

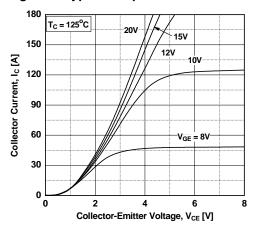


Figure 4. Transfer Characteristics

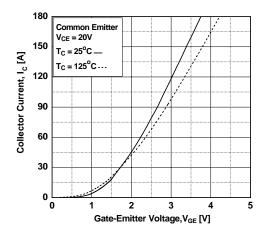


Figure 6. Saturation Voltage vs. V_{GE}

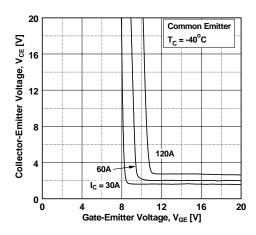


Figure 7. Saturation Voltage vs. V_{GE}

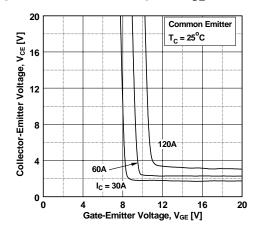


Figure 9. Capacitance Characteristics

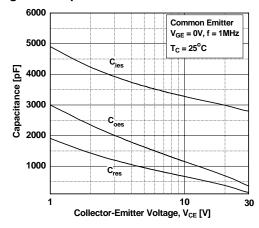


Figure 11. SOA Characteristics

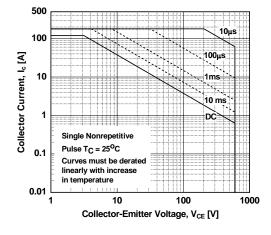


Figure 8. Saturation Voltage vs. V_{GE}

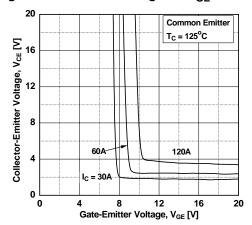


Figure 10. Gate charge Characteristics

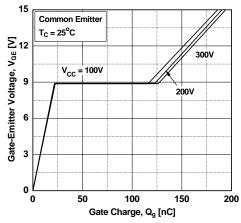


Figure 12. Turn off Switching SOA Characteristics

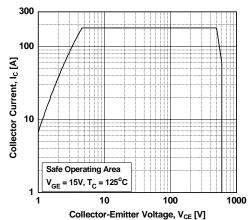


Figure 13. Turn-on Characteristics vs. **Gate Resistance**

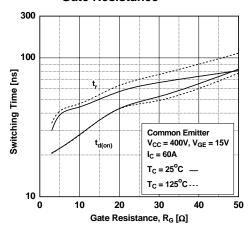


Figure 14. Turn-off Characteristics vs.

Gate Resistance

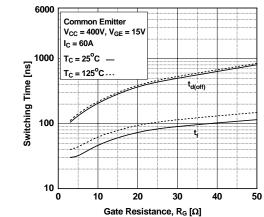


Figure 15. Turn-on Characteristics vs. **Collector Current**

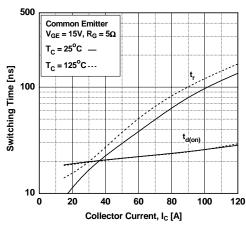


Figure 16. Turn-off Characteristics vs. **Collector Current**

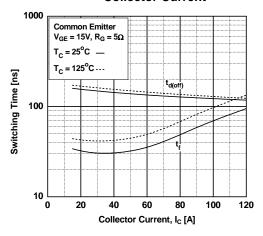


Figure 17. Switching Loss vs Gate Resistance

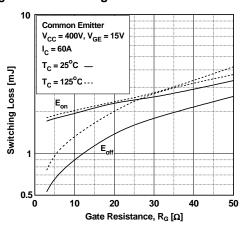


Figure 18. Switching Loss vs Collector Current

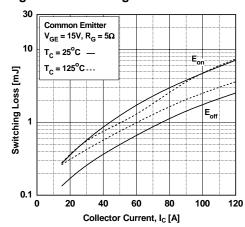


Figure 19. Forward Characteristics

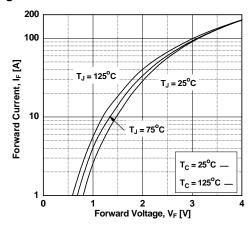


Figure 20. Reverse Current

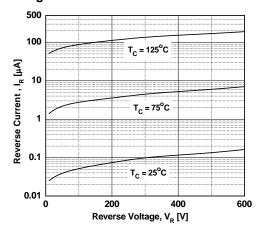


Figure 21. Stored Charge

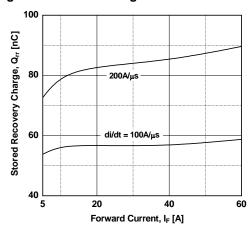


Figure 22. Reverse Recovery Time

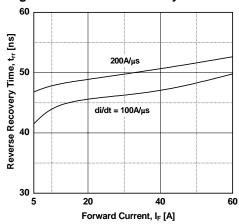
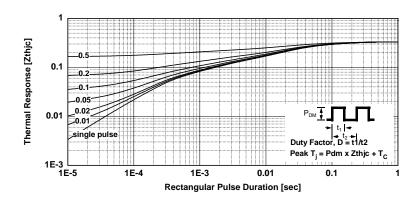
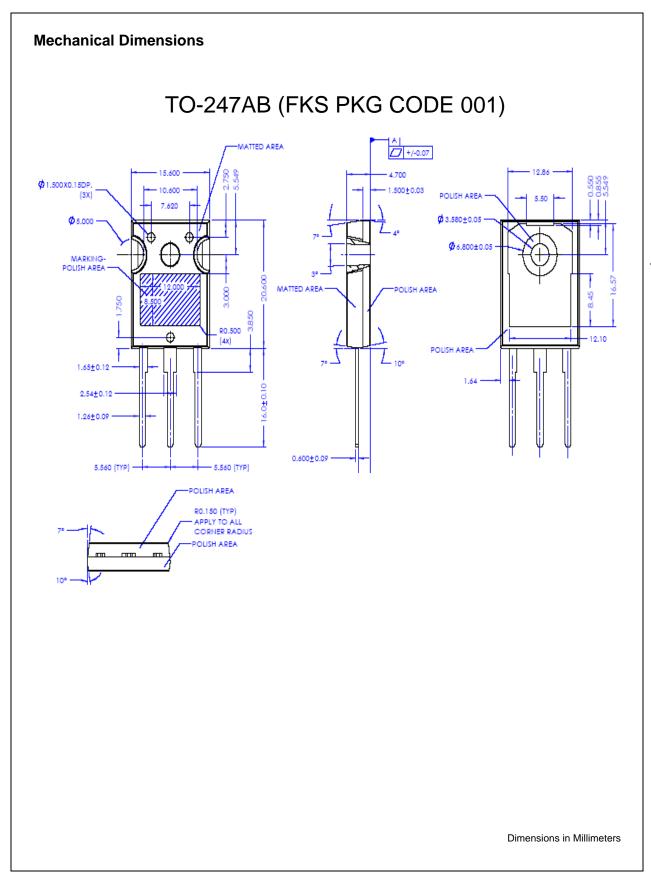


Figure 23. Transient Thermal Impedance of IGBT









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Definition of Terms

Datasheet Identification	Product Status	Definition
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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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